BGA Heat Sink - High Performance maxiFLOW/superGRIP



ATS Part#:

Description:

ATS-X50450P-C1-R0

45.00 x 45.00 x 17.50 mm BGA Heat Sink - High Performance maxiFLOW/superGRIP

Heat Sink Type: Heat Sink Attachment: Equivalent Part Number: N/A

maxiFLOW superGRIP

*Image above is for illustration purpose only.

Features & Benefits

- Designed for 45 x 45 mm components •
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs •
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a • PCB may need to be reworked
- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB .

Thermal Performance

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	1.6 °C/W	1.3 °C/W	1.1 °C/W	1 °C/W	0.9 °C/W	0.9 °C/W	0.8 °C/W
	Ducted Flow	1.3	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	45.00 mm	45.00 mm	17.50 mm	76.5 mm	T766	BLUE-ANODIZED
There above is for illustration purpose only.	 Dimension Thermal p application ATS resense performant ATS certification 	performance data are n. rves the right to upda nce. ies that this heat sin	omponent size. height from the bottor e provided for referen ate or change its prov k assembly is RoHS istom options availat	nce only. Actual perfo ducts without notice -6 and REACH comp	ormance to improv	may vary by

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.



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